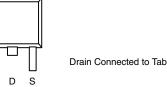


#### Vishay Siliconix

### P-Channel 80 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>b</sup>	Q <sub>g</sub> (Typ)			
- 80	0.0112 at V <sub>GS</sub> = - 10 V	- 110	85 nC			
	0.0145 at V <sub>GS</sub> = - 4.5 V	- 109	05110			

# TO-263



Top View

G

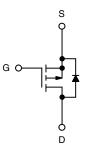
Ordering Information: SUM110P08-11L-E3 (Lead (Pb)-free)

#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



1



P-Channel MOSFET

ABSOLUTE MAXIMUM RATING	<b>S</b> (T <sub>A</sub> = 25 °C, unle	ess otherwise no	oted)	
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	- 80	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	v
	T <sub>C</sub> = 25 °C		- 110 <sup>a</sup>	
Continuous Drain Current (T 175 °C)	T <sub>C</sub> = 125 °C		- 71	
Continuous Drain Current ( $T_J = 175 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 23.5 <sup>b, c</sup>	
	T <sub>A</sub> = 125 °C		- 13.6 <sup>b, c</sup>	Α
Pulsed Drain Current	I <sub>DM</sub>	- 120	A	
Continuous Course Drain Diado Current	T <sub>C</sub> = 25 °C	L.	- 110	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 9 <sup>b, c</sup>	
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 75	
Single-Pulse Avalanche Energy	L = 0.1 IIIH	E <sub>AS</sub>	281	mJ
	T <sub>C</sub> = 25 °C		375	
Marian David Distinction	T <sub>C</sub> = 125 °C		125	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	13.6 <sup>b, c</sup>	— w
	T <sub>A</sub> = 125 °C		4.5 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	8	11	°C/W		
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	0.33	0.4			

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board. c. t = 10 s.

d. Maximum under steady state conditions is 40 °C/W.

Document Number: 73471 For technical questions, contact: pmostechsupport@vishav.com www.vishay.com S12-3071-Rev. C, 24-Dec-12

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#### New Product

## SUM110P08-11L



#### **Vishay Siliconix**

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = -250 \mu A$	- 80			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	l <sub>D</sub> = - 1 μA		- 85		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i <sub>D</sub> = - 1 μΑ		- 5.5			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	- 1		- 3	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
	I <sub>DSS</sub>	$V_{DS} = -80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	μA	
Zero Gate Voltage Drain Current		$V_{DS}$ = - 80 V, $V_{GS}$ = 0 V, $T_{J}$ = 175 °C			- 500		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 120			А	
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 20 A		0.0093	0.0112	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 15 A		0.0120	0.0145		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 20 A		85		S	
Dynamic <sup>b</sup>		· · · · · · · · · · · · · · · · · · ·		<b></b>			
Input Capacitance	C <sub>iss</sub>			10850		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = - 40 V, $V_{GS}$ = 0 V, f = 1 MHz		800			
Reverse Transfer Capacitance	C <sub>rss</sub>			700			
Total Cata Charge	0	$V_{DS}$ = - 40 V, $V_{GS}$ = - 10 V, $I_D$ = - 110 A	= - 110 A 180	270			
Total Gate Charge	Q <sub>g</sub>			85	130	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = - 40 V, $V_{GS}$ = - 4.5 V, $I_D$ = - 110 A		35			
Gate-Drain Charge	Q <sub>gd</sub>			42			
Gate Resistance	Rg	f = 1 MHz		3.6		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			20	30		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 40 V, $R_L$ = 0.36 $\Omega$		330	500	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_{D} \cong$ - 110 A, $V_{GEN}$ = - 10 V, $R_{g}$ = 1 $\Omega$		135	205		
Fall Time	t <sub>f</sub>			550	825		
Drain-Source Body Diode Characteristic	s	•					
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 110	А	
Pulse Diode Forward Currenta	I <sub>SM</sub>				- 120	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 20 A		- 0.8	- 1.5	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			65	100	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			135	205	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	I <sub>F</sub> = - 20 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C		43			
Reverse Recovery Rise Time	t <sub>b</sub>			22		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

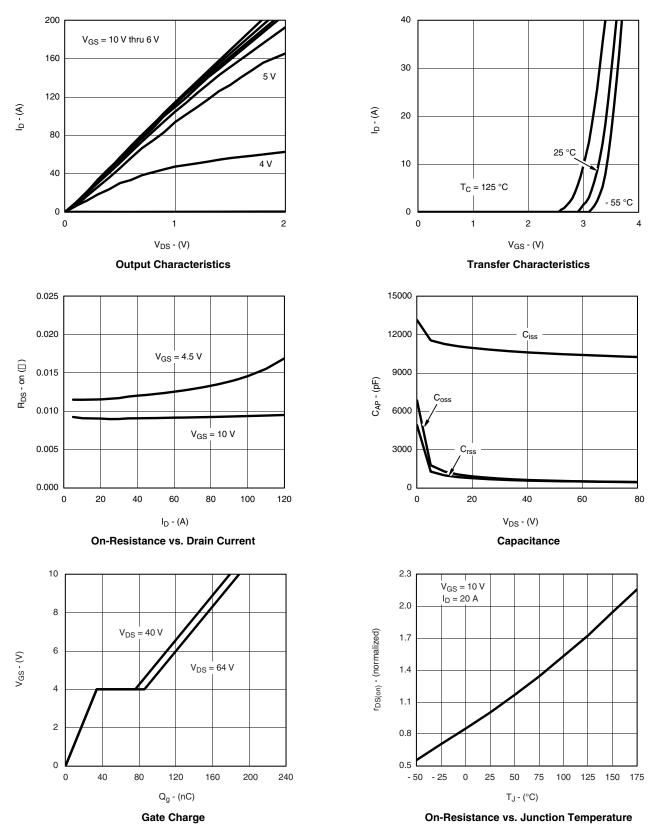
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Vishay Siliconix





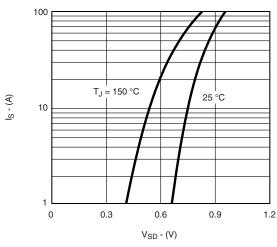
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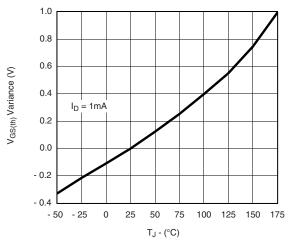


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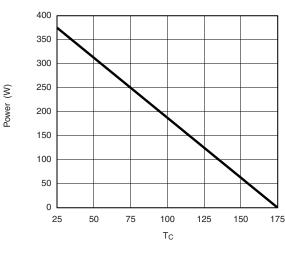




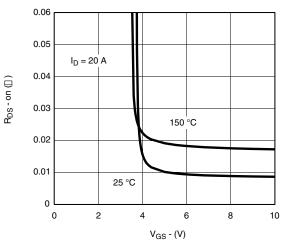
Source-Drain Diode Forward Voltage



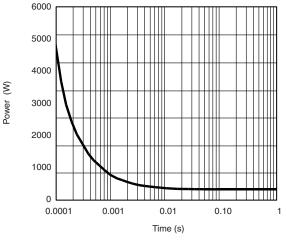




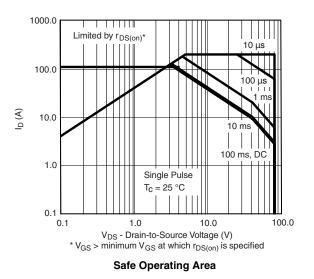
Power Derating, Junction-to-Case



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Case (T<sub>C</sub> = 25 °C)



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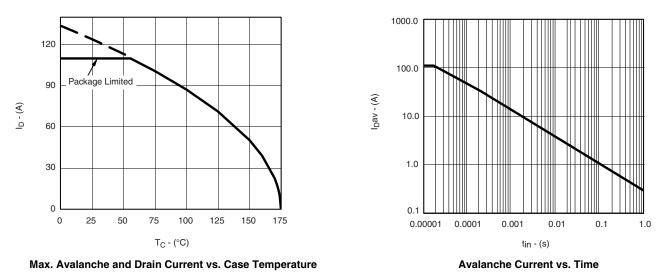
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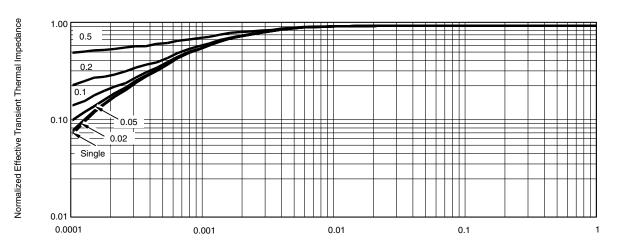




Vishay Siliconix







Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?73471">www.vishay.com/ppg?73471</a>.



**Vishay Siliconix** 

TO-263 (D<sup>2</sup>PAK): 3-LEAD









DETAIL A (ROTATED 90°)



		INCHES		MILLIMETERS			
DIM.		MIN.	MAX.	MIN.	MAX.		
A		0.160	0.190	4.064	4.826		
b		0.020	0.039	0.508	0.990		
	b1	0.020	0.035	0.508	0.889		
	b2	0.045	0.055	1.143	1.397		
С*	Thin lead	0.013	0.018	0.330	0.457		
	Thick lead	0.023	0.028	0.584	0.711		
<u>1</u>	Thin lead	0.013	0.017	0.330	0.431		
c1	Thick lead	0.023	0.027	0.584	0.685		
	c2	0.045	0.055	1.143	1.397		
	D	0.340	0.380	8.636	9.652		
	D1	0.220	0.240	5.588	6.096		
	D2	0.038	0.042	0.965	1.067		
	D3	0.045	0.055	1.143	1.397		
	D4	0.044	0.052	1.118	1.321		
	E	0.380	0.410	9.652	10.414		
E1		0.245	-	6.223	-		
E2		0.355	0.375	9.017	9.525		
E3		0.072	0.078	1.829	1.981		
е		0.100	BSC	2.54	BSC		
К		0.045	0.055	1.143	1.397		
L		0.575	0.625	14.605	15.875		
L1		0.090	0.110	2.286	2.794		
L2		0.040	0.055	1.016	1.397		
L3		0.050	0.070	1.270	1.778		
L4		0.010 BSC 0.254 BS		BSC			
М		-	0.002	-	0.050		
ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843							

#### Notes

- 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25 % of L1 can fall above seating plane by
- max. 8 mils.3. Pin-to-pin coplanarity max. 4 mils.
- 4. \*: Thin lead is for SUB, SYB.
  - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

This feature is for thick lead.

Revison: 30-Sep-13



#### **RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

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